

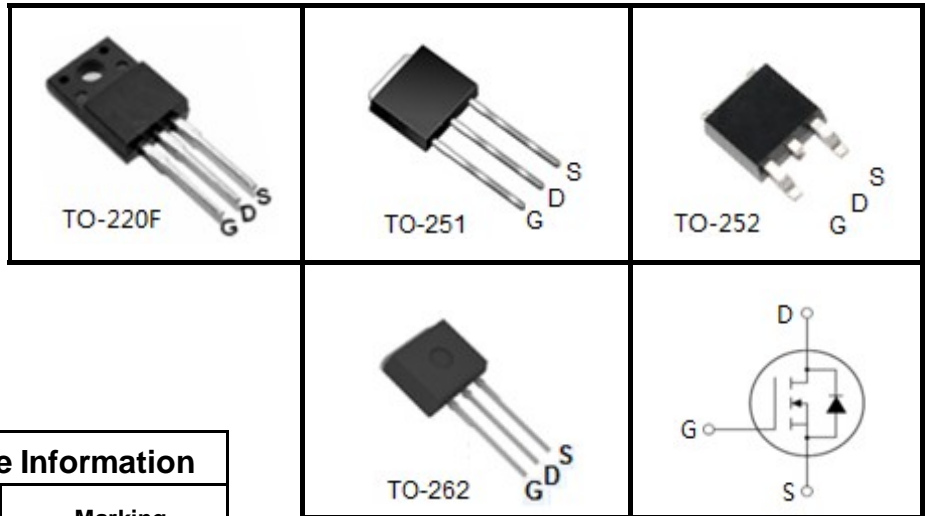
600V N-Channel Enhancement Mode Field Effect Transistor

FEATURES

- Fast switching
- Integrate fast recovery diode
- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Motor Controls
- Power Factor Correction (PFC)



Device Marking and Package Information

Device	Package	Marking
ADFR6N60F	TO-220F	ADFR6N60F
ADFR6N60GL	TO-262	ADFR6N60GL
ADFR6N60D	TO-251	ADFR6N60D
ADFR6N60E	TO-252	ADFR6N60E

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Value				Unit
		TO-220	TO-220F	TO-252	TO-251	
Drain-Source Voltage (V _{GS} = 0V)	V _{DSS}	600				V
Continuous Drain Current	I _D	6				A
Pulsed Drain Current (note1)	I _{DM}	24				A
Gate-Source Voltage	V _{GSS}	± 30				V
Single Pulse Avalanche Energy (note2)	E _{AS}	88				mJ
Avalanche Current (note1)	I _{AR}	4.2				A
Repetitive Avalanche Energy (note1)	E _{AR}	52				mJ
Power Dissipation (T _C = 25°C)	P _D	54	83			W
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150				°C

Thermal Resistance

Parameter	Symbol	Value				Unit
		TO-220F	TO-251	TO-252	TO-262	
Thermal Resistance, Junction-to-Case	R _{thJC}	2.3	1.5			°C/W
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62.5	60			

Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	600	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 600V, V _{GS} = 0V, T _J = 25°C	--	--	1	μA
Gate-Source Leakage	I _{GSS}	V _{GS} = ±30V	--	--	±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = 250μA	3.0	--	4.0	V
Drain-Source On-Resistance (Note3)	R _{DS(on)}	V _{GS} = 10V, I _D = 3.0A	--	1.7	2.0	Ω
Dynamic						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 25V, f = 1.0MHz	--	644	--	pF
Output Capacitance	C _{oss}		--	65	--	
Reverse Transfer Capacitance	C _{rss}		--	7	--	
Total Gate Charge	Q _g	V _{DD} =480V, I _D = 6A, V _{GS} = 10V	--	19	--	nC
Gate-Source Charge	Q _{gs}		--	3.5	--	
Gate-Drain Charge	Q _{gd}		--	11	--	
Turn-on Delay Time	t _{d(on)}	V _{DD} = 300V, I _D =6A, R _G = 25 Ω	--	37	--	ns
Turn-on Rise Time	t _r		--	9	--	
Turn-off Delay Time	t _{d(off)}		--	108	--	
Turn-off Fall Time	t _f		--	40	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I _S	T _C = 25 °C	--	--	6	A
Pulsed Diode Forward Current	I _{SM}		--	--	24	
Body Diode Voltage	V _{SD}	T _J = 25°C, I _{SD} = 3A, V _{GS} = 0V	--	--	1.4	V
Reverse Recovery Time	t _{rr}	V _{GS} = 0V,I _S = 6A, di _F /dt =100A /μs	--	87	--	ns
Reverse Recovery Charge	Q _{rr}		--	0.42	--	μC

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. $L = 10.0mH, V_{DD} = 50V, R_G = 25 \Omega$, Starting $T_J = 25^\circ\text{C}$
3. Pulse Test: Pulse width $\leq 300 \mu s$, Duty Cycle $\leq 1\%$

Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics ($T_J = 25^\circ\text{C}$)

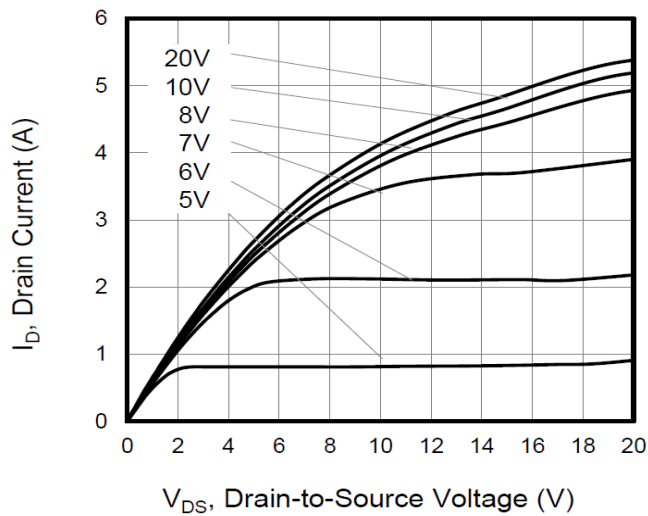


Figure 2. Body Diode Forward Voltage

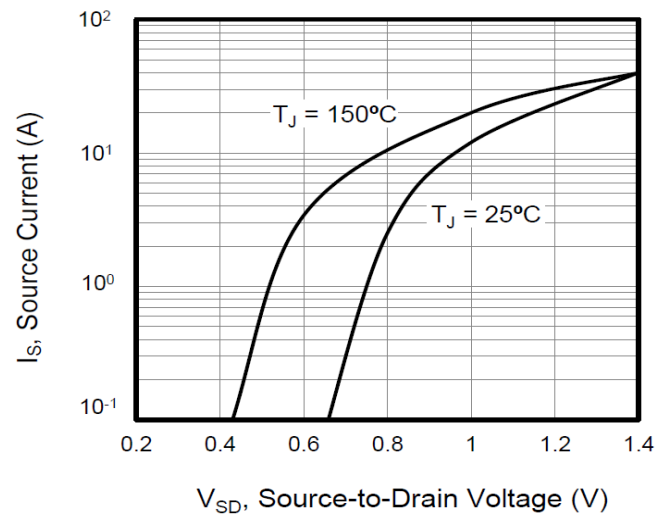


Figure 3. Drain Current vs. Temperature

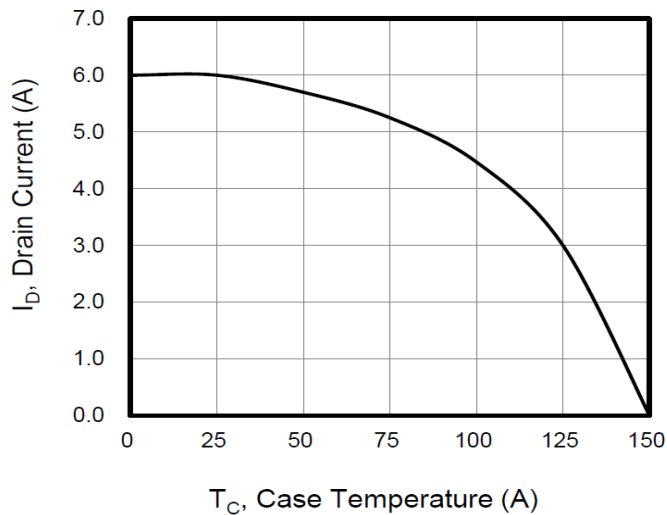


Figure 4. BV_{DSS} Variation vs. Temperature

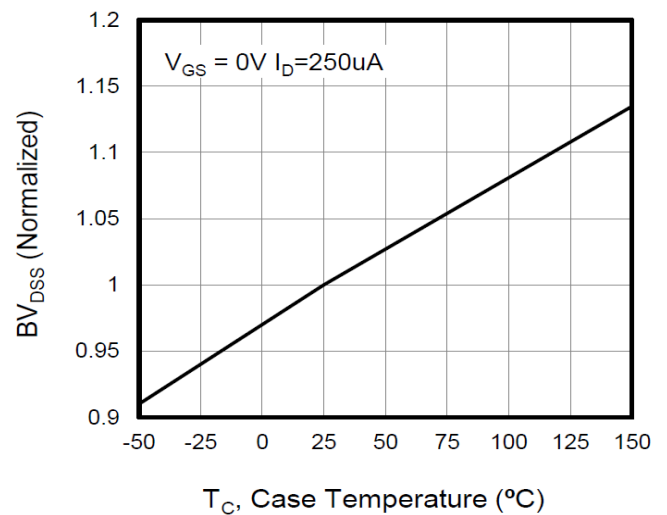


Figure 5. Transfer Characteristics

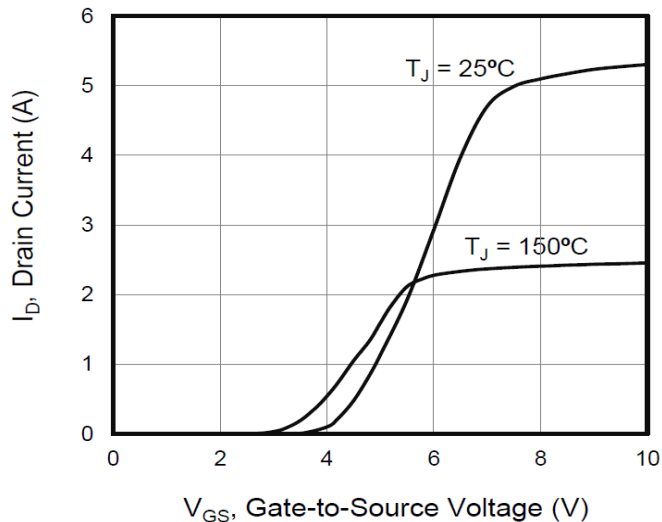


Figure 6. On-Resistance vs. Temperature

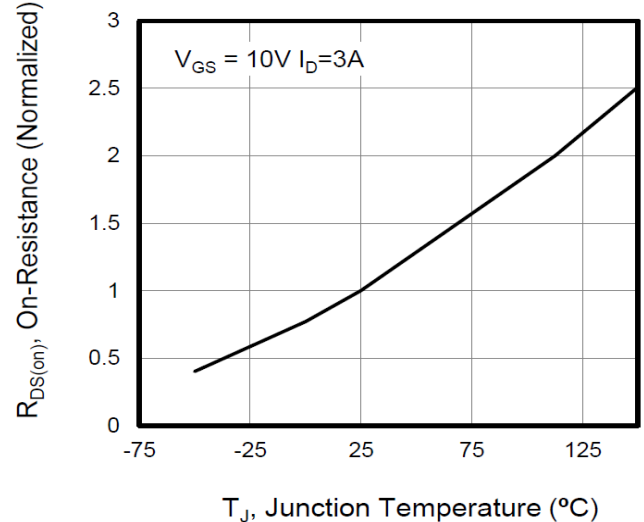


Figure 7. Capacitance

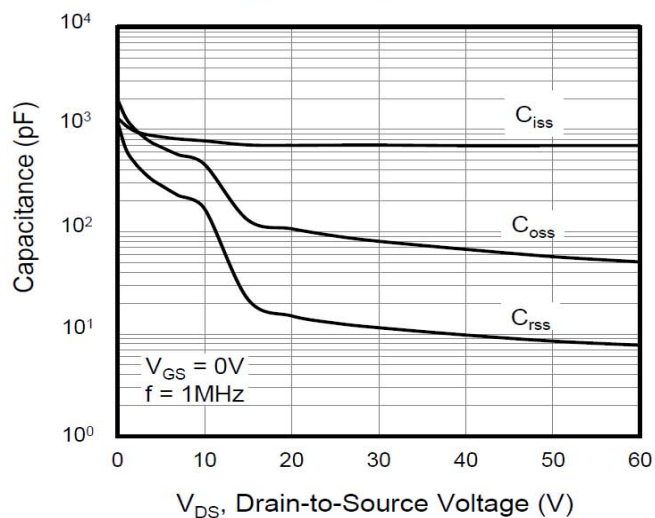


Figure 8. Gate Charge

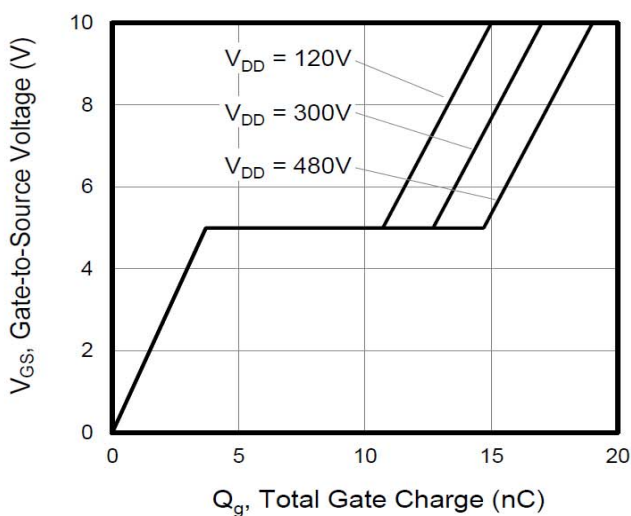


Figure 9. Transient Thermal Impedance
TO-262, TO-251, TO-252

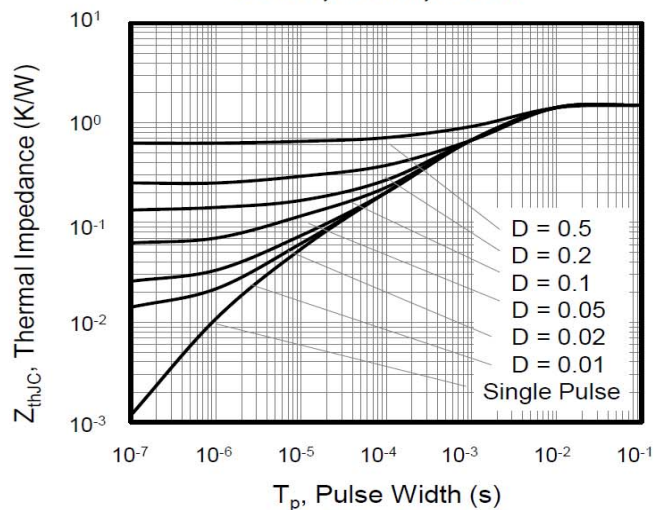


Figure 10. Transient Thermal Impedance
TO-220F

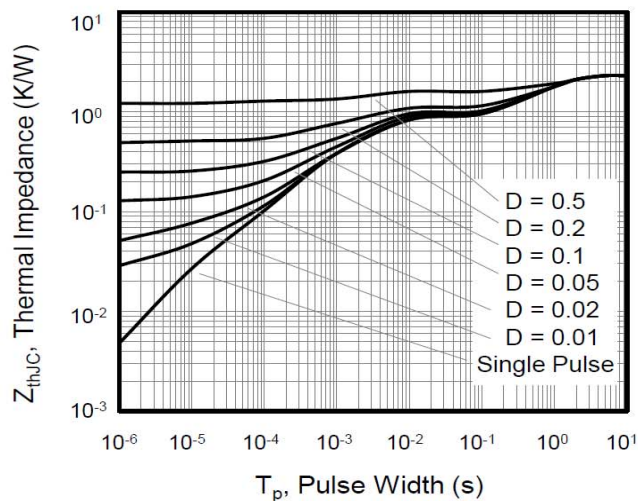


Figure A: Gate Charge Test Circuit and Waveform

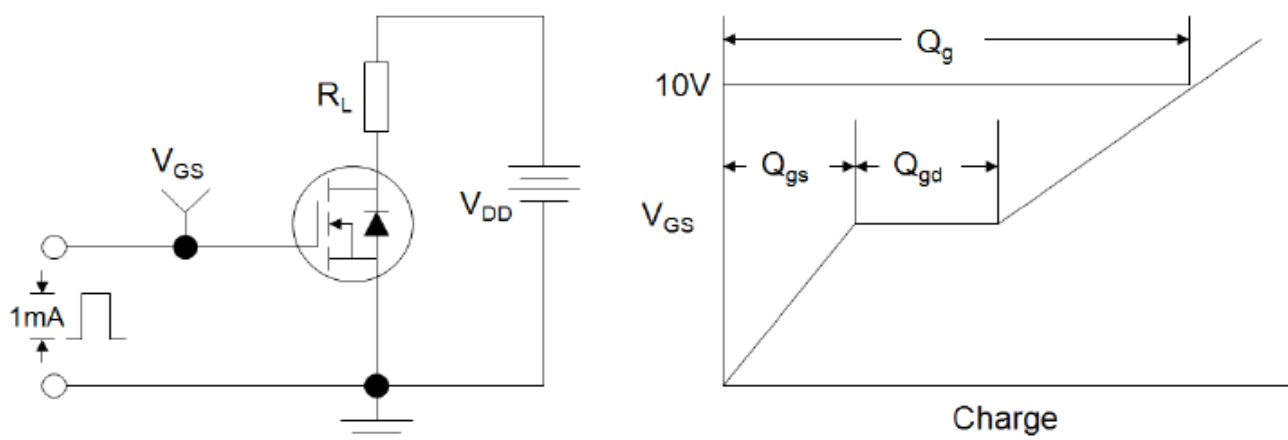


Figure B: Resistive Switching Test Circuit and Waveform

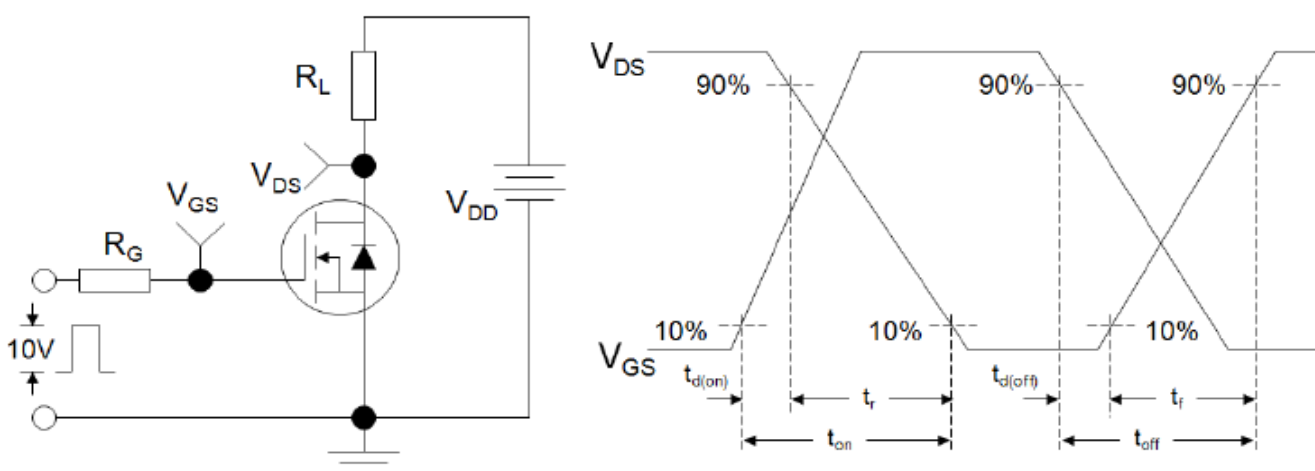
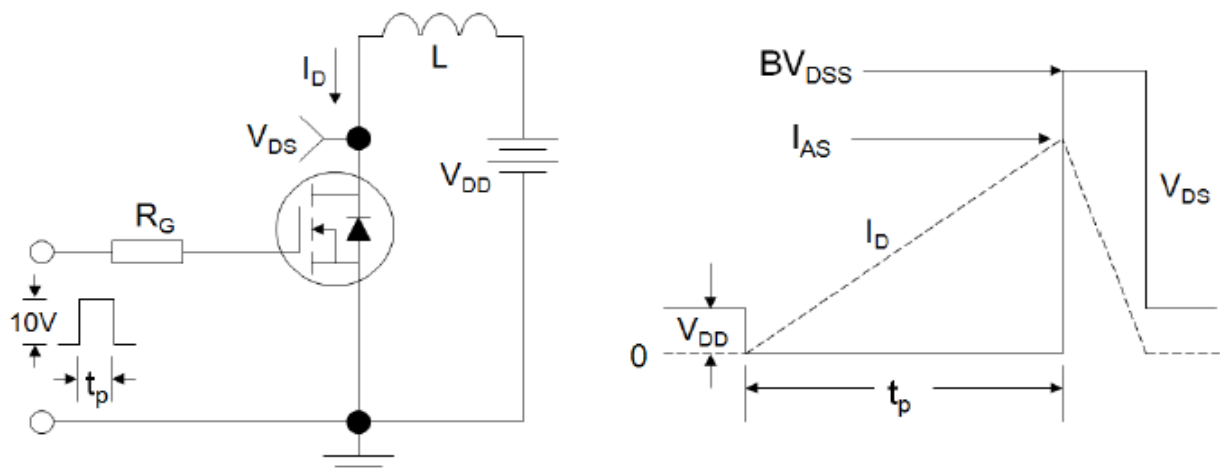
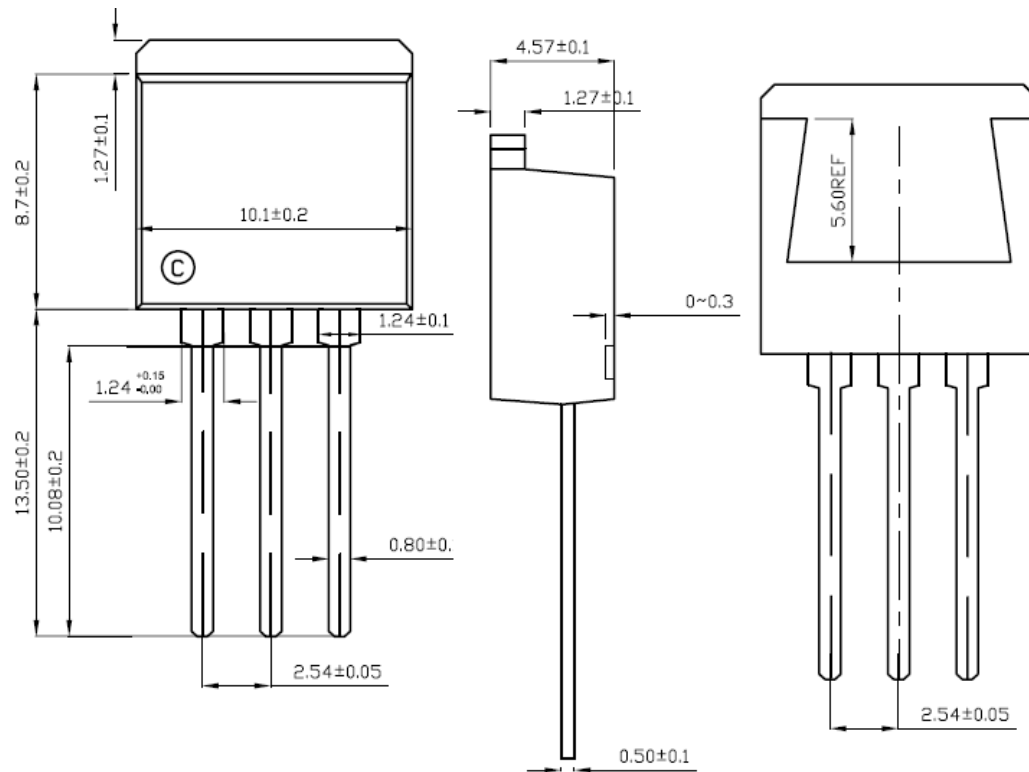


Figure C: Unclamped Inductive Switching Test Circuit and Waveform

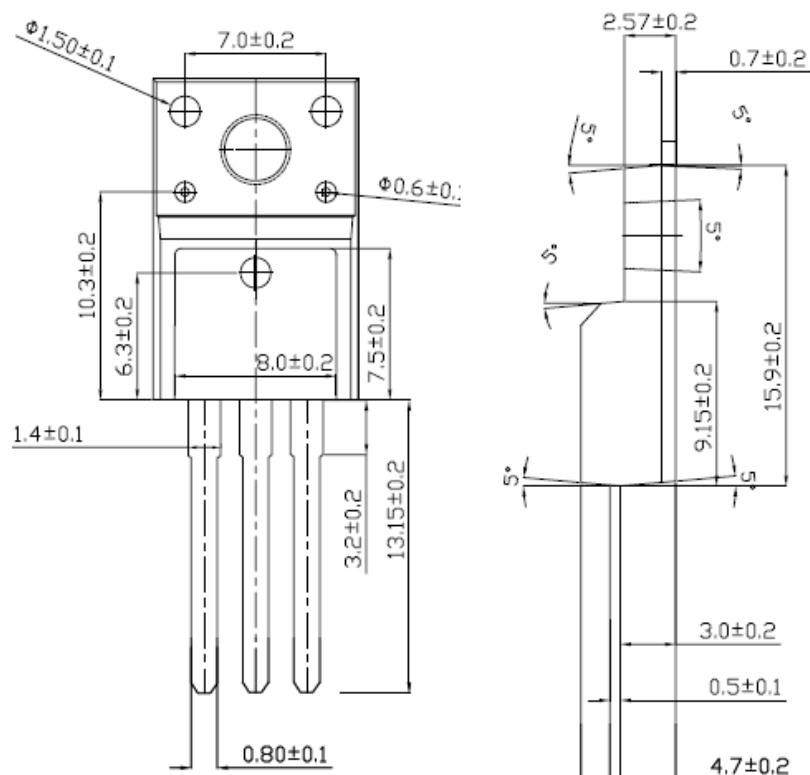


PACKAGE MECHANICAL DATA

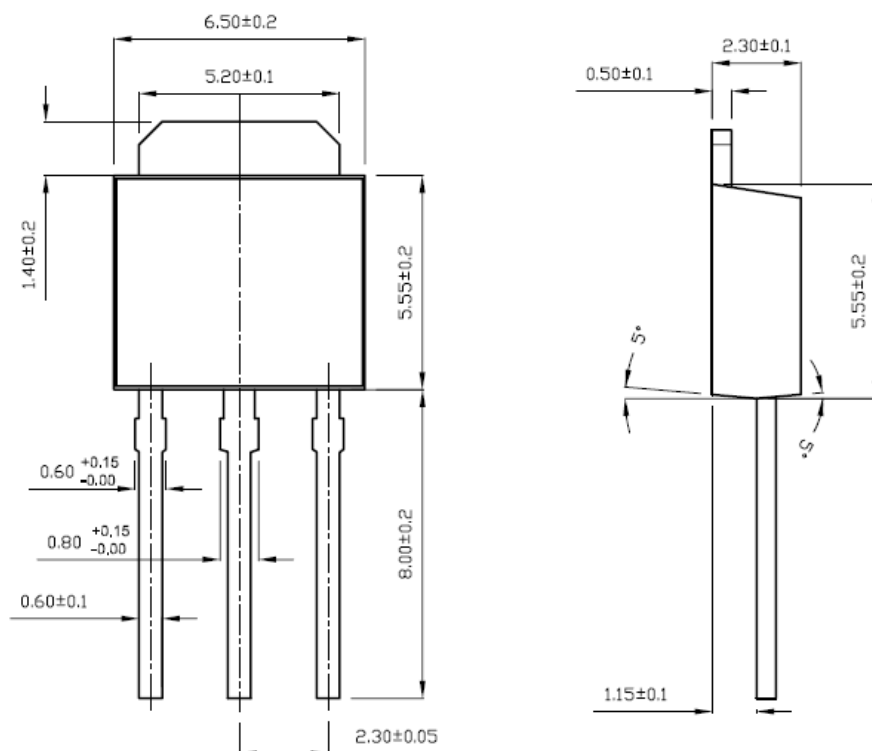
TO-262 Package Dimension



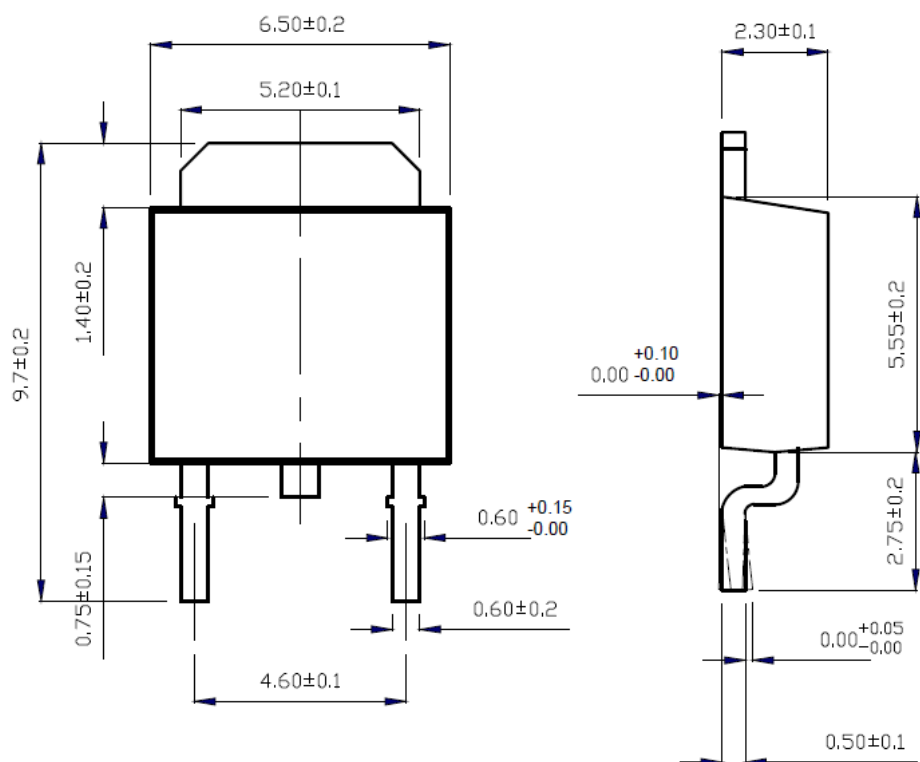
TO-220F Package Dimension



TO-251 Package Dimension



TO-252 Package Dimension



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